

# NLU2G17

## Dual Non-Inverting Schmitt-Trigger Buffer

The NLU2G17 MiniGate™ is an advanced high-speed CMOS dual non-inverting Schmitt-trigger buffer in ultra-small footprint.

The NLU2G17 input and output structures provide protection when voltages up to 7.0 V are applied, regardless of the supply voltage.

The NLU2G17 can be used to enhance noise immunity or to square up slowly changing waveforms.

### Features

- High Speed:  $t_{PD} = 4.0 \text{ ns (Typ) @ } V_{CC} = 5.0 \text{ V}$
- Low Power Dissipation:  $I_{CC} = 1 \mu\text{A (Max) at } T_A = 25^\circ\text{C}$
- Power Down Protection Provided on inputs
- Balanced Propagation Delays
- Overvoltage Tolerant (OVT) Input and Output Pins
- Ultra-Small Packages
- These are Pb-Free Devices

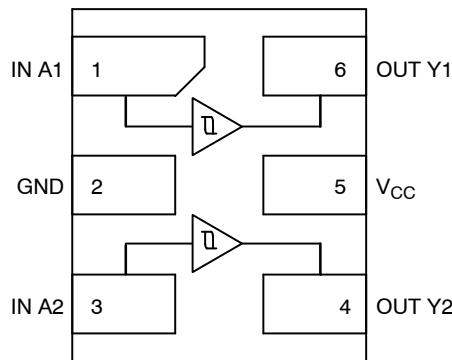


Figure 1. Pinout (Top View)

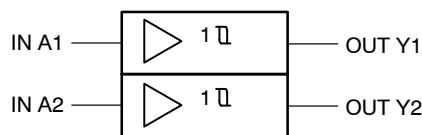


Figure 2. Logic Symbol

### PIN ASSIGNMENT

|   |                 |
|---|-----------------|
| 1 | IN A1           |
| 2 | GND             |
| 3 | IN A2           |
| 4 | OUT Y2          |
| 5 | V <sub>CC</sub> |
| 6 | OUT Y1          |

### FUNCTION TABLE

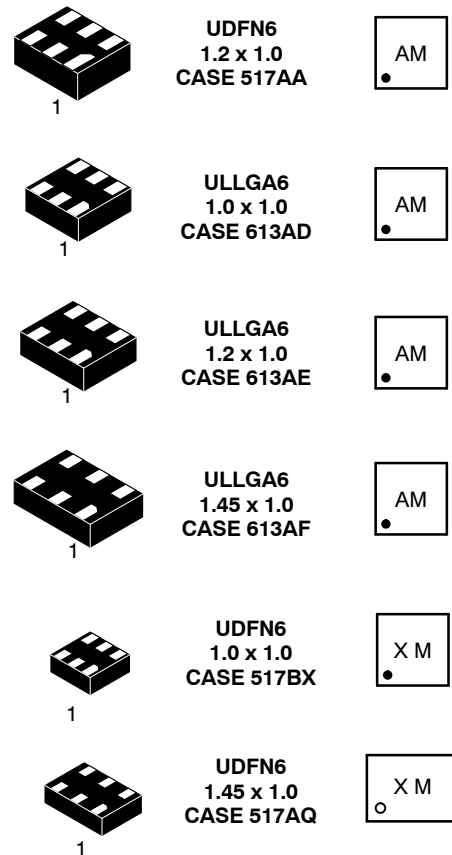
| A | Y |
|---|---|
| L | L |
| H | H |



ON Semiconductor®

<http://onsemi.com>

### MARKING DIAGRAMS



A = Device Marking  
M = Date Code

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

# NLU2G17

## MAXIMUM RATINGS

| Symbol               | Parameter   | Value                | Unit |
|----------------------|---|----------------------|------|
| V <sub>CC</sub>      | DC Supply Voltage   | -0.5 to +7.0         | V    |
| V <sub>IN</sub>      | DC Input Voltage  | -0.5 to +7.0         | V    |
| V <sub>OUT</sub>     | DC Output Voltage   | -0.5 to +7.0         | V    |
| I <sub>IK</sub>      | DC Input Diode Current<br>V <sub>IN</sub> < GND                           | -20                  | mA   |
| I <sub>OK</sub>      | DC Output Diode Current<br>V <sub>OUT</sub> < GND                         | ±20                  | mA   |
| I <sub>O</sub>       | DC Output Source/Sink Current   | ±12.5                | mA   |
| I <sub>CC</sub>      | DC Supply Current Per Supply Pin  | ±25                  | mA   |
| I <sub>GND</sub>     | DC Ground Current per Ground Pin  | ±25                  | mA   |
| T <sub>STG</sub>     | Storage Temperature Range   | -65 to +150          | °C   |
| T <sub>L</sub>       | Lead Temperature, 1 mm from Case for 10 Seconds                           | 260                  | °C   |
| T <sub>J</sub>       | Junction Temperature Under Bias   | 150                  | °C   |
| MSL                  | Moisture Sensitivity  | Level 1              |      |
| F <sub>R</sub>       | Flammability Rating Oxygen<br>Index: 28 to 34                             | UL 94 V-0 @ 0.125 in |      |
| I <sub>LATCHUP</sub> | Latchup Performance Above V <sub>CC</sub> and Below GND at 125°C (Note 2) | ±500                 | mA   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow.
2. Tested to EIA / JESD78.

## RECOMMENDED OPERATING CONDITIONS

| Symbol           | Parameter  | Min    | Max                  | Unit |
|------------------|--|--------|----------------------|------|
| V <sub>CC</sub>  | Positive DC Supply Voltage   | 1.65   | 5.5                  | V    |
| V <sub>IN</sub>  | Digital Input Voltage  | 0      | 5.5                  | V    |
| V <sub>OUT</sub> | Output Voltage   | 0      | 5.5                  | V    |
| T <sub>A</sub>   | Operating Free-Air Temperature   | -55    | +125                 | °C   |
| Δt/ΔV            | Input Transition Rise or Fall Rate<br>V <sub>CC</sub> = 3.3 V ± 0.3 V<br>V <sub>CC</sub> = 5.0 V ± 0.5 V | 0<br>0 | No Limit<br>No Limit | ns/V |

# NLU2G17

## DC ELECTRICAL CHARACTERISTICS

| Symbol          | Parameter                         | Conditions  | V <sub>CC</sub> (V) | T <sub>A</sub> = 25 °C |      |      | T <sub>A</sub> = +85°C |      | T <sub>A</sub> = -55°C to +125°C |      | Unit |
|-----------------|-----------------------------------|---|---------------------|------------------------|------|------|------------------------|------|----------------------------------|------|------|
|                 |                                   |   |                     | Min                    | Typ  | Max  | Min                    | Max  | Min                              | Max  |      |
| V <sub>T+</sub> | Positive Threshold Voltage        |   | 3.0                 | 1.85                   | 2.0  | 2.2  |                        | 2.2  |                                  | 2.2  | V    |
|                 |                                   |   | 4.5                 | 2.86                   | 3.0  | 3.15 |                        | 3.15 |                                  | 3.15 |      |
|                 |                                   |   | 5.5                 | 3.50                   | 3.6  | 3.85 |                        | 3.85 |                                  | 3.85 |      |
| V <sub>T-</sub> | Negative Threshold Voltage        |   | 3.0                 | 0.9                    | 1.5  | 1.65 | 0.9                    |      | 0.9                              |      | V    |
|                 |                                   |   | 4.5                 | 1.35                   | 2.3  | 2.46 | 1.35                   |      | 1.35                             |      |      |
|                 |                                   |   | 5.5                 | 1.65                   | 2.9  | 3.05 | 1.65                   |      | 1.65                             |      |      |
| V <sub>H</sub>  | Hysteresis Voltage                |   | 3.0                 | 0.30                   | 0.57 | 1.20 | 0.30                   | 1.20 | 0.30                             | 1.20 | V    |
|                 |                                   |   | 4.5                 | 0.40                   | 0.67 | 1.40 | 0.40                   | 1.40 | 0.40                             | 1.40 |      |
|                 |                                   |   | 5.5                 | 0.50                   | 0.74 | 1.60 | 0.50                   | 1.60 | 0.50                             | 1.60 |      |
| V <sub>OH</sub> | Minimum High-Level Output Voltage | V <sub>IN</sub> ≥ V <sub>T+</sub> MAX<br>I <sub>OH</sub> = -50 μA                           | 2.0                 | 1.9                    | 2.0  |      | 1.9                    |      | 1.9                              |      | V    |
|                 |                                   |   | 3.0                 | 2.9                    | 3.0  |      | 2.9                    |      | 2.9                              |      |      |
|                 |                                   | 4.5   | 4.4                 | 4.5                    |      | 4.4  |                        | 4.4  |                                  |      |      |
|                 |                                   | V <sub>IN</sub> ≥ V <sub>T+</sub> MAX<br>I <sub>OH</sub> = -4 mA<br>I <sub>OH</sub> = -8 mA | 3.0                 | 2.58                   |      |      | 2.48                   |      | 2.34                             |      |      |
| 4.5             | 3.94                              |   |                     | 3.80                   |      | 3.66 |                        |      |                                  |      |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage  | V <sub>IN</sub> ≤ V <sub>T-</sub> MIN<br>I <sub>OL</sub> = 50 μA                            | 2.0                 |                        | 0    | 0.1  |                        | 0.1  |                                  | 0.1  | V    |
|                 |                                   |   | 3.0                 |                        | 0    | 0.1  |                        | 0.1  |                                  | 0.1  |      |
|                 |                                   |   | 4.5                 |                        | 0    | 0.1  |                        | 0.1  |                                  | 0.1  |      |
|                 |                                   | V <sub>IN</sub> ≤ V <sub>T-</sub> MIN<br>I <sub>OL</sub> = 4 mA<br>I <sub>OL</sub> = 8 mA   | 3.0                 |                        |      | 0.36 |                        | 0.44 |                                  | 0.52 |      |
| 4.5             |                                   |   |                     | 0.36                   |      | 0.44 |                        | 0.52 |                                  |      |      |
| I <sub>IN</sub> | Input Leakage Current             | 0 ≤ V <sub>IN</sub> ≤ 5.5 V   | 0 to 5.5            |                        |      | ±0.1 |                        | ±1.0 |                                  | μA   |      |
| I <sub>CC</sub> | Quiescent Supply Current          | 0 ≤ V <sub>IN</sub> ≤ V <sub>CC</sub>   | 5.5                 |                        |      | 1.0  |                        | 10   |                                  | μA   |      |

## AC ELECTRICAL CHARACTERISTICS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0 ns)

| Symbol                                 | Parameter                                      | V <sub>CC</sub> (V) | Test Condition         | T <sub>A</sub> = 25 °C |     |      | T <sub>A</sub> = +85°C |      | T <sub>A</sub> = -55°C to +125°C |      | Unit |
|--|--|---------------------|------------------------|------------------------|-----|------|------------------------|------|----------------------------------|------|------|
|  |  |                     |                        | Min                    | Typ | Max  | Min                    | Max  | Min                              | Max  |      |
| t <sub>pLH</sub> ,<br>t <sub>pHL</sub> | Propagation Delay, Input A to Output $\bar{Y}$ | 3.0 to 3.6          | C <sub>L</sub> = 15 pF |                        | 7.0 | 12.8 | 1.0                    | 15   | 1.0                              | 17   | ns   |
|  |  |                     | C <sub>L</sub> = 50 pF |                        | 8.5 | 16.3 | 1.0                    | 18.5 | 1.0                              | 20.5 |      |
|  |  | 4.5 to 5.5          | C <sub>L</sub> = 15 pF |                        | 4.0 | 8.6  | 1.0                    | 10   | 1.0                              | 11.5 |      |
|  |  |                     | C <sub>L</sub> = 50 pF |                        | 5.5 | 10.6 | 1.0                    | 12   | 1.0                              | 13.5 |      |
| C <sub>IN</sub>                        | Input Capacitance                              |                     |                        |                        | 5.0 | 10   |                        | 10   |                                  | pF   |      |
| C <sub>PD</sub>                        | Power Dissipation Capacitance (Note 3)         | 5.0                 |                        |                        | 7.0 |      |                        |      |                                  | pF   |      |

3. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the dynamic operating current consumption without load. Average operating current can be obtained by the equation I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

# NLU2G17

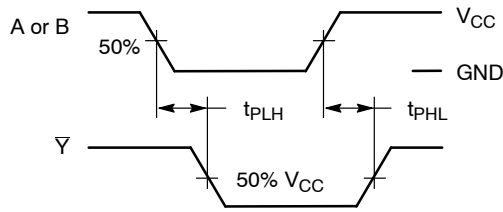
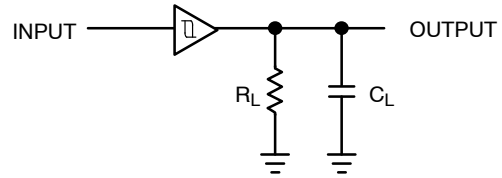
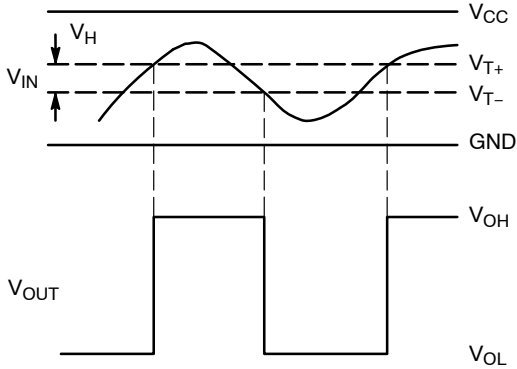


Figure 3. Switching Waveforms

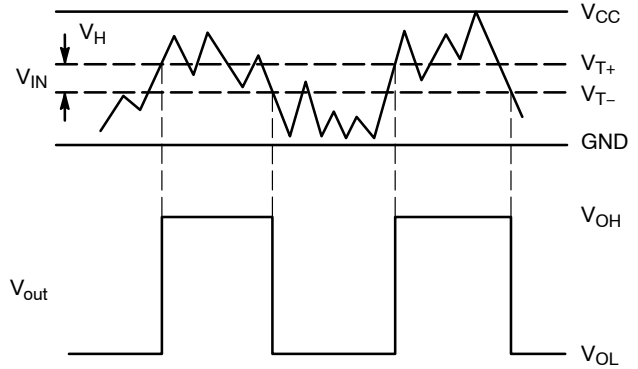


A 1-MHz square input wave is recommended for propagation delay tests.

Figure 4. Test Circuit



(a) A Schmitt-Trigger Squares Up Inputs With Slow Rise and Fall Times



(b) A Schmitt-Trigger Offers Maximum Noise Immunity

Figure 5. Typical Schmitt-Trigger Applications

## ORDERING INFORMATION

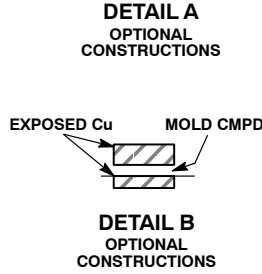
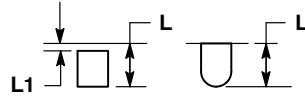
| Device         | Package                               | Shipping†          |
|----------------|---------------------------------------|--------------------|
| NLU2G17MUTCG   | UDFN6, 1.2 x 1.0, 0.4P<br>(Pb-Free)   | 3000 / Tape & Reel |
| NLU2G17AMX1TCG | ULLGA6, 1.45 x 1.0, 0.5P<br>(Pb-Free) | 3000 / Tape & Reel |
| NLU2G17BMX1TCG | ULLGA6, 1.2 x 1.0, 0.4P<br>(Pb-Free)  | 3000 / Tape & Reel |
| NLU2G17CMX1TCG | ULLGA6, 1.0 x 1.0, 0.35P<br>(Pb-Free) | 3000 / Tape & Reel |
| NLU2G17AMUTCG  | UDFN6, 1.45 x 1.0, 0.5P<br>(Pb-Free)  | 3000 / Tape & Reel |
| NLU2G17CMUTCG  | UDFN6, 1.0 x 1.0, 0.35P<br>(Pb-Free)  | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NLU2G17

## PACKAGE DIMENSIONS

UDFN6 1.45x1.0, 0.5P  
CASE 517AQ  
ISSUE O

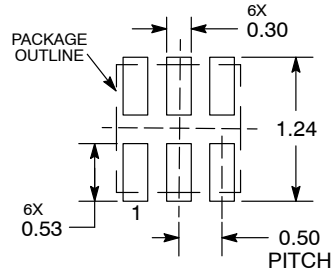


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.

| MILLIMETERS |          |      |
|-------------|----------|------|
| DIM         | MIN      | MAX  |
| A           | 0.45     | 0.55 |
| A1          | 0.00     | 0.05 |
| A2          | 0.07 REF |      |
| b           | 0.20     | 0.30 |
| D           | 1.45 BSC |      |
| E           | 1.00 BSC |      |
| e           | 0.50 BSC |      |
| L           | 0.30     | 0.40 |
| L1          | ---      | 0.15 |

### MOUNTING FOOTPRINT



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NLU2G17

## PACKAGE DIMENSIONS

UDFN6 1.0x1.0, 0.35P  
CASE 517BX  
ISSUE O

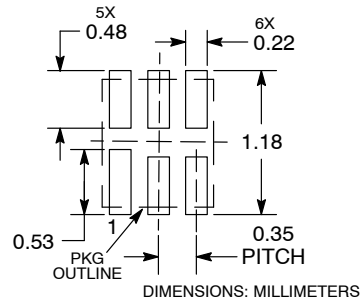


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

| MILLIMETERS |          |      |
|-------------|----------|------|
| DIM         | MIN      | MAX  |
| A           | 0.45     | 0.55 |
| A1          | 0.00     | 0.05 |
| A3          | 0.13 REF |      |
| b           | 0.12     | 0.22 |
| D           | 1.00 BSC |      |
| E           | 1.00 BSC |      |
| e           | 0.35 BSC |      |
| L           | 0.25     | 0.35 |
| L1          | 0.30     | 0.40 |

### RECOMMENDED SOLDERING FOOTPRINT\*

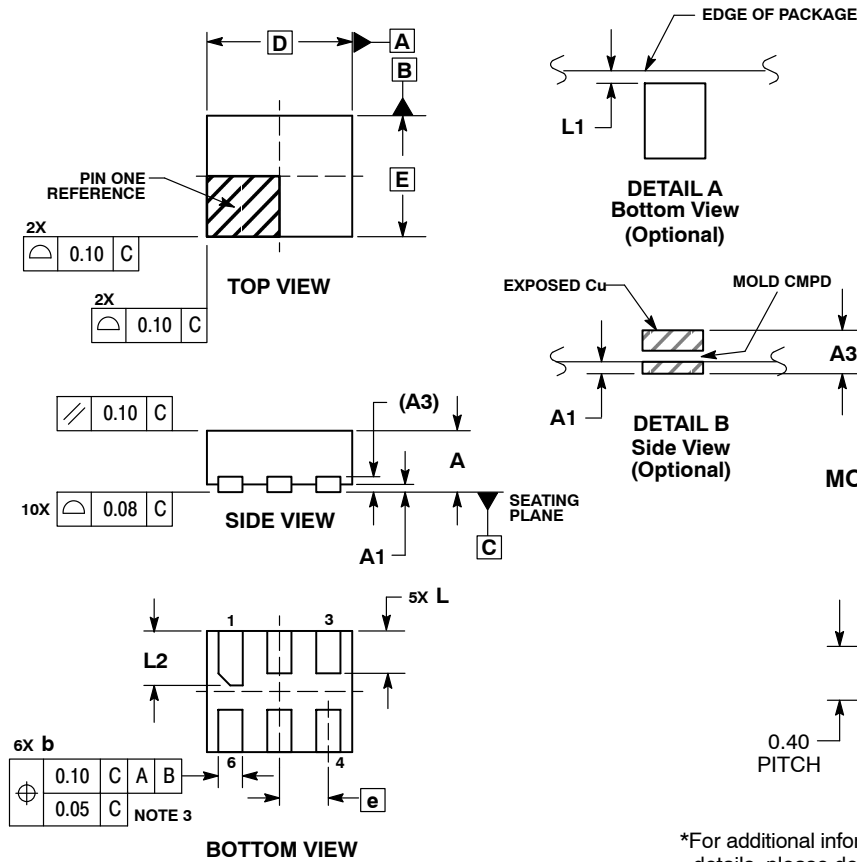


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NLU2G17

## PACKAGE DIMENSIONS

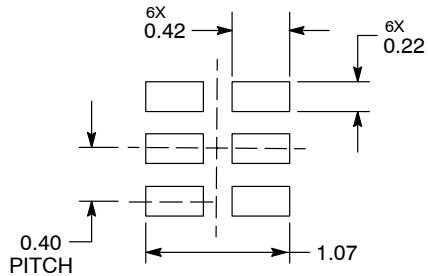
UDFN6, 1.2x1.0, 0.4P  
CASE 517AA  
ISSUE C



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. DIMENSION *b* APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 mm FROM TERMINAL.
  4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| MILLIMETERS |       |      |
|-------------|-------|------|
| DIM         | MIN   | MAX  |
| A           | 0.45  | 0.55 |
| A1          | 0.00  | 0.05 |
| A3          | 0.127 | REF  |
| b           | 0.15  | 0.25 |
| D           | 1.20  | BSC  |
| E           | 1.00  | BSC  |
| e           | 0.40  | BSC  |
| L           | 0.30  | 0.40 |
| L1          | 0.00  | 0.15 |
| L2          | 0.40  | 0.50 |

### MOUNTING FOOTPRINT\*



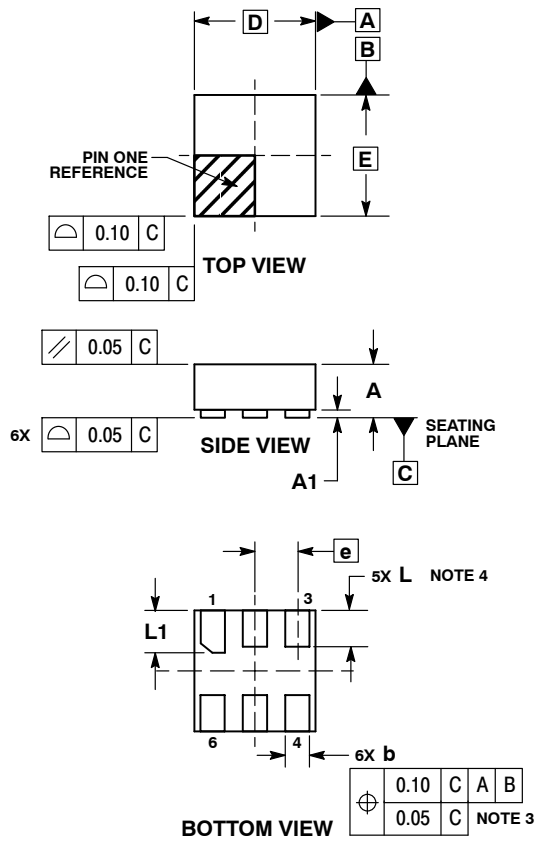
DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NLU2G17

## PACKAGE DIMENSIONS

ULLGA6 1.0x1.0, 0.35P  
CASE 613AD  
ISSUE A

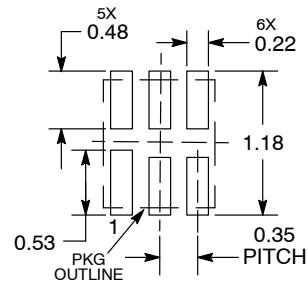


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
4. A MAXIMUM OF 0.05 mm PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS |          |      |
|-------------|----------|------|
| DIM         | MIN      | MAX  |
| A           | ---      | 0.40 |
| A1          | 0.00     | 0.05 |
| b           | 0.12     | 0.22 |
| D           | 1.00 BSC |      |
| E           | 1.00 BSC |      |
| e           | 0.35 BSC |      |
| L           | 0.25     | 0.35 |
| L1          | 0.30     | 0.40 |

### MOUNTING FOOTPRINT SOLDERMASK DEFINED\*



DIMENSIONS: MILLIMETERS

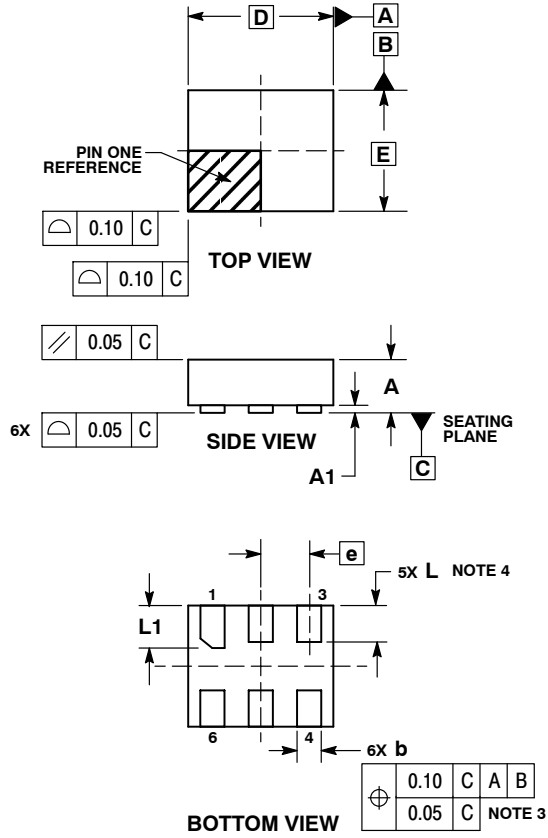
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



# NLU2G17

## PACKAGE DIMENSIONS

ULLGA6 1.2x1.0, 0.4P  
CASE 613AE  
ISSUE A

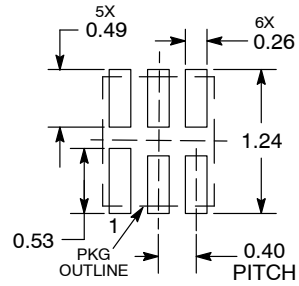


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
4. A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS |          |      |
|-------------|----------|------|
| DIM         | MIN      | MAX  |
| A           | ---      | 0.40 |
| A1          | 0.00     | 0.05 |
| b           | 0.15     | 0.25 |
| D           | 1.20 BSC |      |
| E           | 1.00 BSC |      |
| e           | 0.40 BSC |      |
| L           | 0.25     | 0.35 |
| L1          | 0.35     | 0.45 |

**MOUNTING FOOTPRINT  
SOLDEMASK DEFINED\***



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NLU2G17

## PACKAGE DIMENSIONS

ULLGA6 1.45x1.0, 0.5P  
CASE 613AF  
ISSUE A

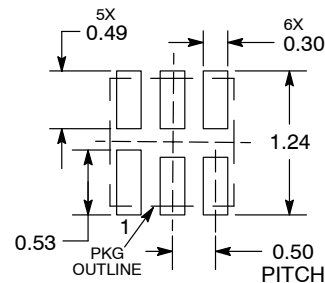


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
4. A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS |          |      |
|-------------|----------|------|
| DIM         | MIN      | MAX  |
| A           | ---      | 0.40 |
| A1          | 0.00     | 0.05 |
| b           | 0.15     | 0.25 |
| D           | 1.45 BSC |      |
| E           | 1.00 BSC |      |
| e           | 0.50 BSC |      |
| L           | 0.25     | 0.35 |
| L1          | 0.30     | 0.40 |

### MOUNTING FOOTPRINT SOLDERMASK DEFINED\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

MiniGate is a trademark of Semiconductor Components Industries, LLC (SCILLC).

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

### PUBLICATION ORDERING INFORMATION

**LITERATURE FULFILLMENT:**  
Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».



**JONHON**

«**JONHON**» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«**FORSTAR**» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А